

P-Channel 20-V (D-S) MOSFET

Description

These miniature surface mount MOSFETs utilize a high cell density trench process to provide low rDS(on) and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

Features

Low rDS(on) provides higher efficiency and extends
battery life

• Low thermal impedance copper leadframe SC70-3 saves board space

- · Fast switching speed
- · High performance trench technology
- RoHS compliant package

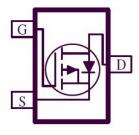
Packing & Order Information

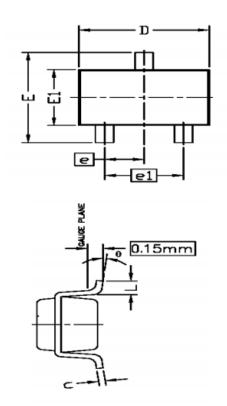
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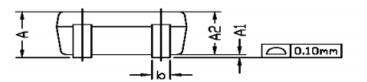




Graphic symbol







FYMBOLS	DIMENSIONS IN MILLIMBTERS			DIMENSIONS IN INCHES			
SIMBOLS	MIN	NOM	MAX	MIN	NOM	MAX	
Α			1.10			0.043	
A1	0.00	Ι	0.10	0.00		0.004	
A2	0.7	0.9	1.00	0.028	0.028 0.035 0.039		
b	0.15		0.30	0.006		0.012	
c	0.08	-	0.22	0.003	_	0.009	
D	1.85	2,10	2,15	0.073	0.083	0.085	
E	1.80	2.30	2.40	0.071	0.091	0.094	
e	0.65 BSC			0.026 BSC			
el	1.30 BSC			0.051 BSC			
E 1	1.1	1.30	1.4	0.043	0.051	0.055	
L	0.26	0.36	0.46	0.010	0.014	0.018	
Ð	0°	4°	8°	0°	4°	8°	



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MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings (T _A =25°C unless otherwise specified)					
Symbol	Parameter	Value	Unit		
V _{DS}	Drain-Source Voltage	-20	V		
V _{GS}	Gate-Source Voltage	±8	V		
L	Continuous Drain Current ^a (T _A =25°C)	-1.7	А		
ID	Continuous Drain Current _a (T _A =70°C)	-1.4	А		
I _{DM}	Pulsed Drain Current ^b	-2.5	А		
I _S	Continuous Source Current (Diode Conduction) ^a	±0.28	А		
D	Power Dissipation ^a (T _A =25°C)	0.34	W		
P _D	Power Dissipation ^a (T _A =70°C)	0.22	W		
T _J /T _{STG}	Operating Junction and Storage Temperature	-55 to +150	°C		

THERMAL RESISTANCE RATINGS						
Symbol	Parameter	Maximum	Units			
KTU IA	Maximum Junction-to-Ambient C/W ^a (t <= 5 sec)	375	°C/W			
	Maximum Junction-to-Ambient C/W ^a (Steady-State)	430	C/VV			

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

b. Pulse width limited by maximum junction temperature

Static						
Symbol	Parameter	Test Conditions	Min	Тур.	Max.	Units
V_{GS}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-0.4			V
I _{GSS}	Gate-Body Leakage	$V_{DS} = 0 V$, $V_{GS} = \pm 8 V$			±100	nA
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -16 V$, $V_{GS} = 0 V$ $V_{DS} = -16 V$, $V_{GS} = 0 V$, $T_{J} = 55^{\circ}C$			-1 -10	uA
I _{D(on)}	On-State Drain Current ^A	$V_{DS} = -5 V, V_{Gs} = -4.5 V$	-5			А
I _{DS(on)}	Drain-Source On-Resistance ^A	$V_{GS} = -4.5 \text{ V}, I_D = -1.7 \text{ A}$ $V_{GS} = -2.5 \text{ V}, I_D = -1.5 \text{ A}$			79 110	mΩ
g _{fs}	Forward Tranconductance ^A	V _{DS} = -5V, I _D = -1.25 A		9		S
V _{SD}	Diode Forward Voltage	$I_{\rm S}$ = -0.46 V, $V_{\rm GS}$ = 0 V		-0.65		V

Dynamic ^b							
Symbol	Parameter	Test Conditions	Min	Тур.	Max.	Units	
t _{d(on)}	Turn-On Delay Time	$V_{DD} = -10 \text{ V}$, $I_L = -1 \text{ A}$, $V_{GEN} = -4.5 \text{ V}$, $R_G = 6 \Omega$		10		ns	
t _r	Rise Time			9		ns	
t _{d(off)}	Turn-Off Delay Time			27		ns	
tf	Fall Time			11		ns	



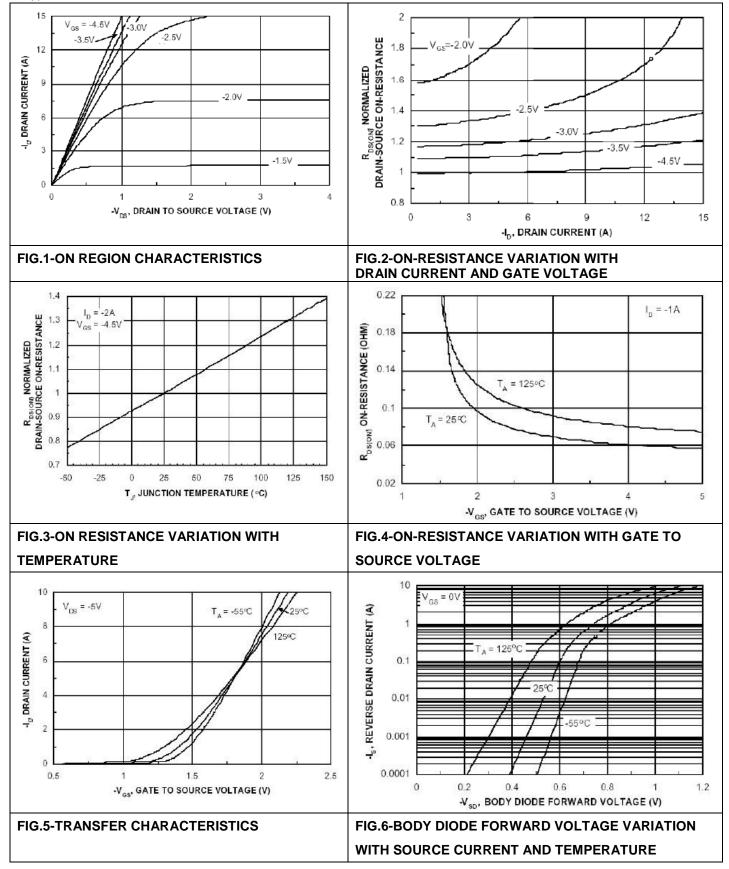
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Dynamic ^b							
Symbol	Parameter	Test Conditions	Min	Тур.	Max.	Units	
Qg	Total Gate Charge	V_{DS} = -10 V , I_{D} = -1.7 A, V_{GS} = -4.5 V		7.2		nC	
Q _{gs}	Gate-Source Charge			1.7		nC	
Q_gd	Gate-Drain Charge			1.5		nC	



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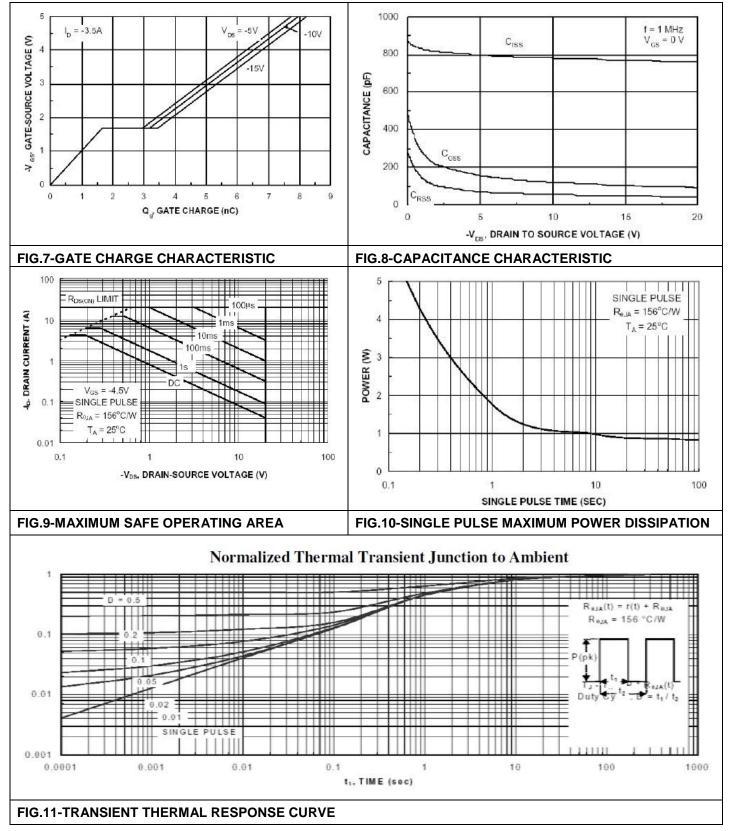
Typical Electrical Characteristics





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Typical Electrical Characteristics





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